

ZZ1 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per Table 1

ZZ2 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 3, unless otherwise specified.

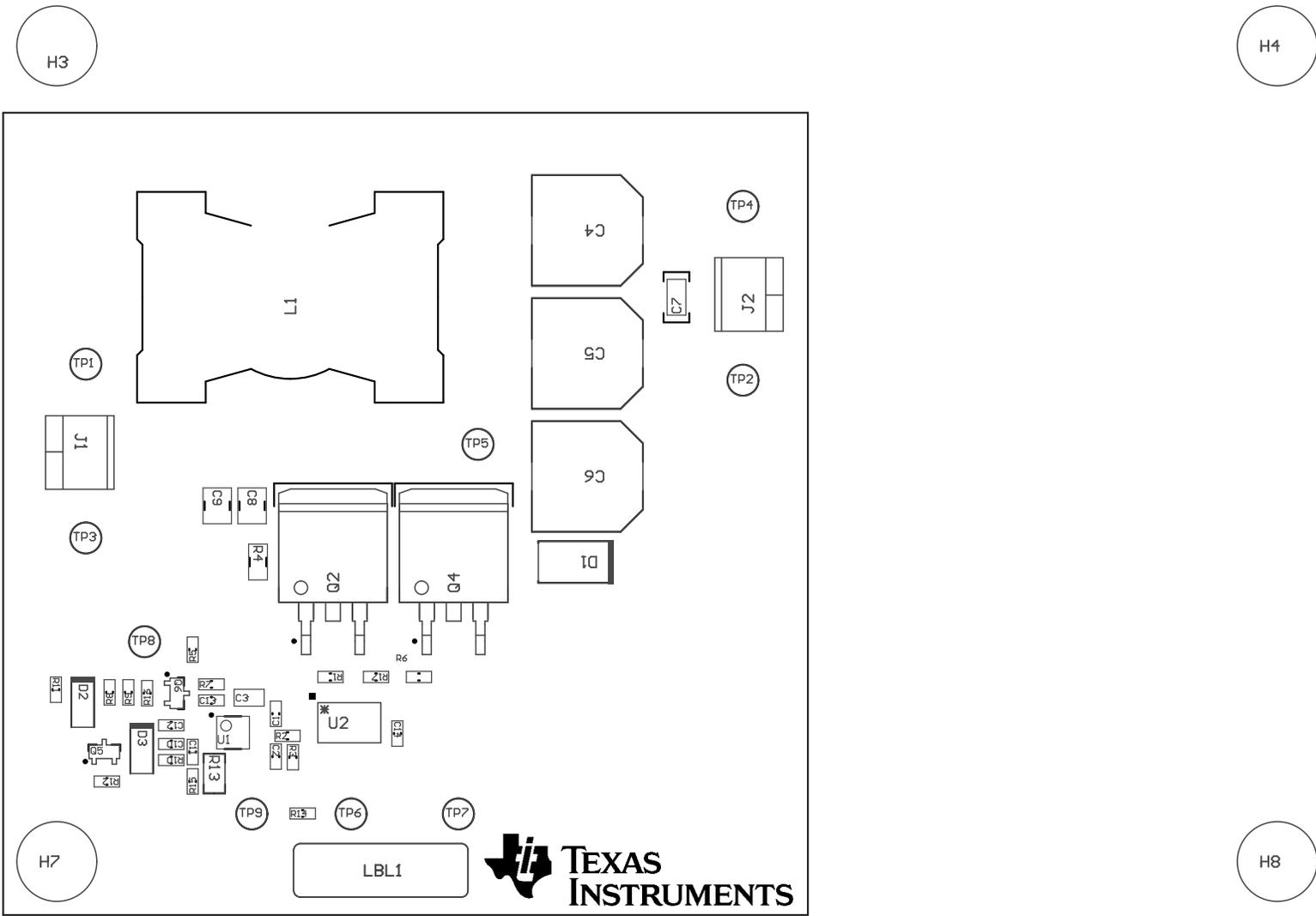
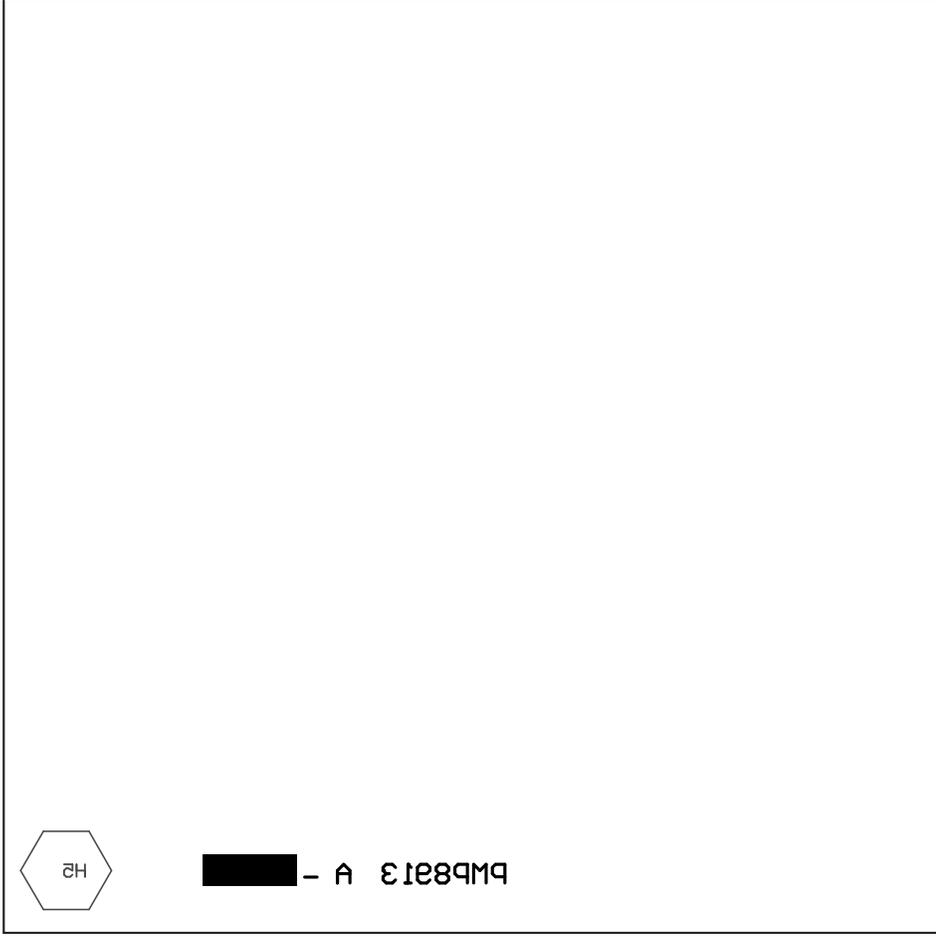


TABLE 1

Variant	Label text
001	ChangeMe!
002	ChangeMe!

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED, AND MAY NOT BE IN BILL OF MATERIALS
ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP8913	REV: A	SUN REV: Not In VersionControl
IGNORE -> Top Overlay			
PLOT NAME = Top Assembly Drawing	GENERATED : 2/15/2013 1:55:33 PM	TEXAS INSTRUMENTS	



ASSEMBLY VARIANT: 001
 COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED, AND MAY NOT BE IN BILL OF MATERIALS

PLOT NAME = Bottom Assembly Drawing	GENERATED : 2/15/2013 1:55:33 PM	TEXAS INSTRUMENTS
PCB VIEWED FROM BOTTOM SIDE	IGNORE ->	Bottom Overlay
BOARD #: PMP8913	REV: A	SUN REV: Not In VersionControl

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